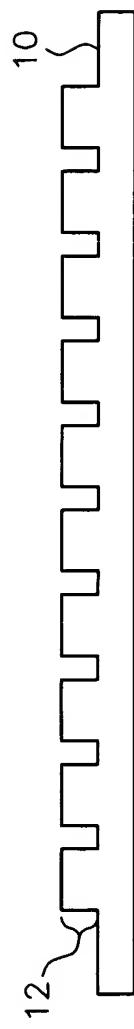
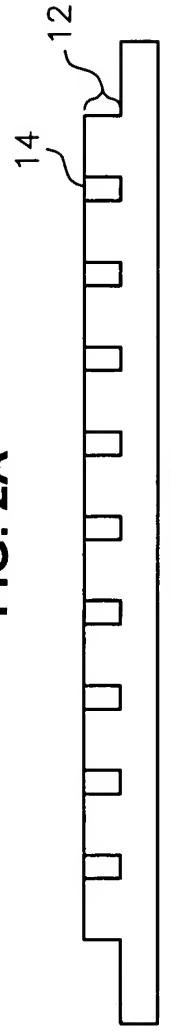


Step 1.  
KGD w/base Substrate



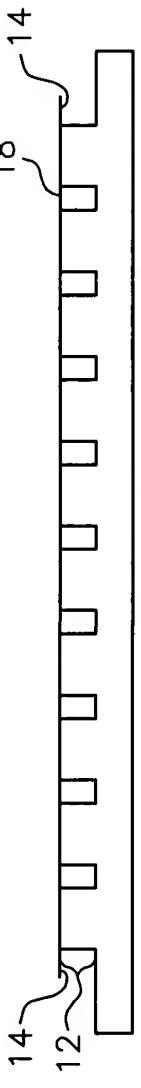
**FIG. 2A**

Step 2.  
Deposition of  
Photoresist Mask



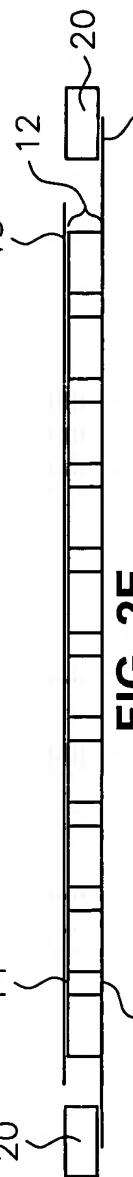
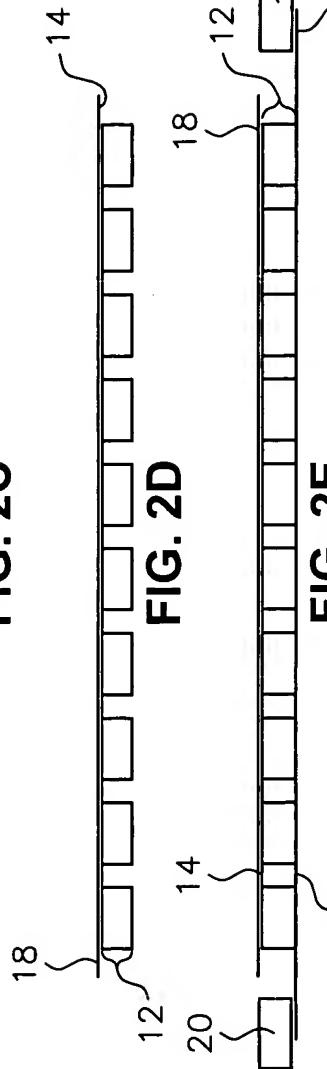
**FIG. 2B**

Step 3.  
Add Back Grinding  
Tape



**FIG. 2C**

Step 4.  
Grind Substrate and die  
to Backside of die

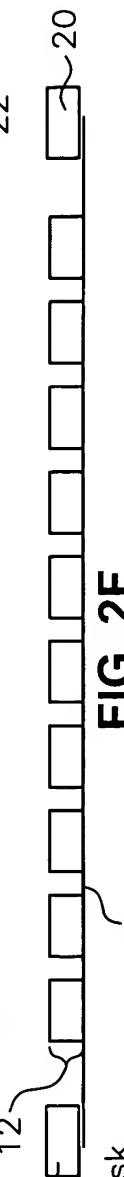
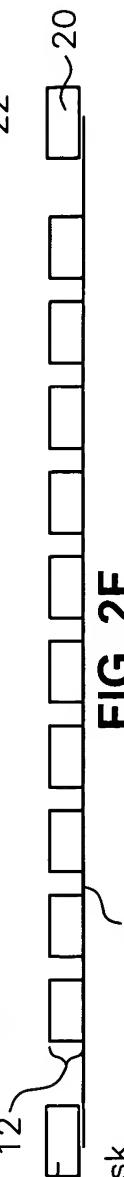


**FIG. 2D**



**FIG. 2E**

Step 6.  
Remove Back Grinding  
Tape and Photoresist mask



**FIG. 2F**